



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Adrian E. Ong
Title: Layout And Use Of Bond Pads And Probe Pads For Testing Of
Integrated Circuits Devices
Application No.: 10/003,375
Filing Date: November 15, 2001
Examiner: Tung X. Nguyen
Group Art Unit: 2829
Confirmation No.: 4697
Office: Sidley Austin Brown & Wood LLP
Commissioner For Patents, P.O. Box 1450
Alexandria, VA 22313-1450

PETITION FOR EXTENSION OF TIME

Dear Sir:

Applicants respectfully petition for a two-month extension of time within which to respond to the June 18, 2003 outstanding Office Action, such extension allowing the undersigned until November 18, 2003 to respond.

Please charge the amount of \$210.00 as set forth in the enclosed transmittal letter.

EXPRESS MAIL LABEL NO.:

Respectfully submitted,

EV 305 257 465 US

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By:

Peter G. Mikhail
Attorney of Record
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PGM/rp

November 18, 2003

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